

Test Your Dream !

AF8862C7

Burn-in & Test System

This system gives you the high-precision and high-performance Memory IC Test Burn-In solution with small dimensions, additional capacity and IO pins that provides better productivity to users.

- Number of zone : 1 zone(Temp/Control)
- Number of slot : 60 slots
- Number of oven : 1 oven
- Temperature : -10℃ ~ 150℃
- Temp. Resolution : 0.1℃
- Temp. accuracy : $\pm 2^{\circ}\text{C}$ (-10℃ ~ +25℃ / 3.5kW)
 $\pm 3^{\circ}\text{C}$ (+25℃ ~ +125℃ / 7kW)
 $\pm 4^{\circ}\text{C}$ (+125℃ ~ +150℃ / 7kW)
- Burn-in Board Size : 450mm× 570mm×1.6mm
- Burn-in Board Density : Depend on power consumption
- Burn-in Board ID : 24 bits
- ALPG address : 44bits (X: 22bits, Y: 22bits)
- Power voltage range : PS1/PS2/PS3/PS4: +0.5V~+10V /15A
PS1/PS2: +0.5V~+10V/30A
- Option : Flash function



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